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Part Number:

0737803254

Status:

Active

Overview:

HDM Backplane Connector System

Description:

HDM Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 144 Circuits, Mounted Height 14.00mm, Pin Length 3.50mm, Press-Fit



Series image - Reference only

Documents:	
3D Model	Product Specification PS-73780-999-001 (PDF)
Drawing (PDF)	Application Specification AS-73670-9998-001 (PDF)
3D Model (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
UL	E29179
General	
Product Family	Backplane Connectors
Series	73780
Application	Daughtercard, Mezzanine
Comments	Press-Fit Tail
Component Type	PCB Receptacle
Data Rate	1.0 Gbps
Overview	HDM Backplane Connector System
Product Name	HDM
Taxonomy	Backplane Connectors
UPC	800756571355
Physical	
Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Tin
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Net Weight	19.022/g
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length	3.50mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762µm
Plating min - Termination	0.889µm
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55° to +105°C

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

REACH SVHC

Not Contained Per -
D(2022)4187-DC (10
June 2022)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

Green Image

ELV

Not Relevant

RoHS Phthalates

Not Contained

Search Parts in this Series

73780 Series

Mates With

HDM Board-to-Board Backplane Header
[73642](#) , [73643](#) , [73644](#) , [73942](#) , [73943](#) ,
[73944](#) , [74349](#) , [74428](#). HDM Board-to-
Board Stacking Header [73769](#) , [73770](#) ,
[73782](#) , [73783](#) , [73771](#)

Termination Interface: Style	Through Hole - Compliant Pin
Electrical	
Current - Maximum per Contact	15.0A, 1.0A
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC
Solder Process Data	
Lead-freeProcess Capability	N/A
Material Info	
Reference - Drawing Numbers	
Application Specification	AS-73670-9998-001
Product Specification	PS-73780-999-001
Sales Drawing	SD-73780-001-001

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